

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: VISHNU K. AGARWAL AND
DINESH CHOPRA
FILED: CONCURRENTLY HEREWITH
FOR: **METHOD AND APPARATUS FOR
FORMING A PLANARIZING PAD FOR
PLANARIZATION OF
MICROELECTRONIC SUBSTRATES**

Preliminary Amendment

Mail Stop Patent Application
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Commissioner:

Prior to examination on the merits, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2.

Amendments to the Claims are reflected in the listing of claims beginning on page 3.